

MOSFET

OptiMOS[™]5 Power-Transistor, 100 V

Features

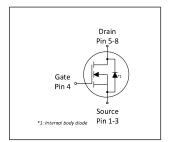
- Ideal for high frequency switching
 Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 N-channel, Logic level
 100% avalanche tested

- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



- a.c 110 j : 011011111111100 : arailletoro							
Parameter	Value	Unit					
V _{DS}	100	V					
R _{DS(on),max}	14.6	m $Ω$					
I _D	44	A					
Qoss	20	nC					
Q _G (0V4.5V)	8	nC					











Type / Ordering Code	Package	Marking	Related Links
BSZ146N10LS5	PG-TSDSON-8 FL	146N10L	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

	Constant	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	ID	- - -	-	44 28 9	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =10 V, T _A =25 °C, R _{thJA} =60K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	176	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	30	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	52 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Davamatar	Cumbal	Values			11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R_{thJC}	-	1.4	2.4	K/W	-
Device on PCB, minimal footprint	R_{thJA}	-	-	62	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	-	-	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

D	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.7	2.3	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =23 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	16.0 12.4	20.8 14.6	mΩ	V _{GS} =4.5 V, I _D =10 A V _{GS} =10 V, I _D =20 A
Gate resistance ¹⁾	R _G	-	1	1.5	Ω	-
Transconductance	g_{fs}	18	36	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 20 A$

 Table 5
 Dynamic characteristics

Parameter	Sumb al	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1000	1300	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	170	220	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	9	15	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	4.7	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	3.2	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	14.3	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	3.2	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Sumb al	Values			1 1 m 14	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	3.2	-	nC	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	1.6	-	nC	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	2.8	4.1	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	4.4	-	nC	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Q_{g}	-	7.6	9.5	nC	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	3.2	-	V	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	15	-	-	V_{DD} =50 V, I_{D} =20 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	20	27	nC	V _{DD} =50 V, V _{GS} =0 V

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

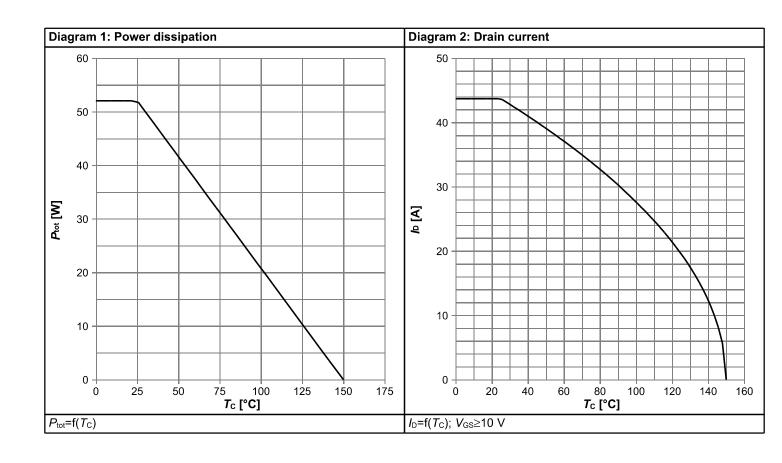


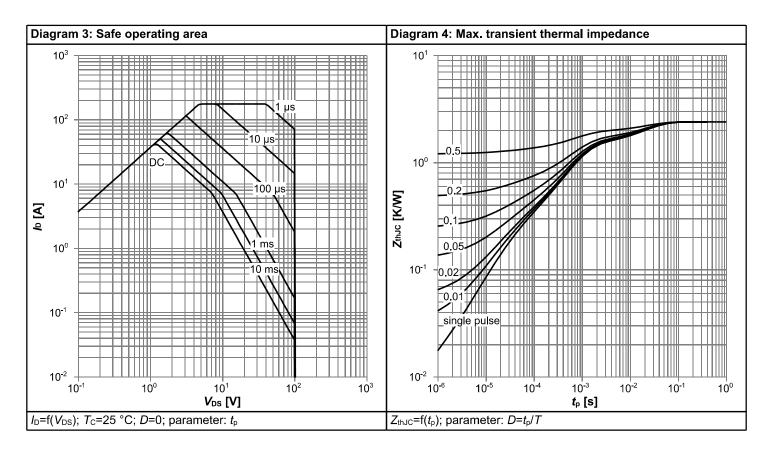
Table 7 Reverse diode

Davamatar	Cumbal	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	42	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	176	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	26	52	ns	V _R =50 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	19	38	nC	V _R =50 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

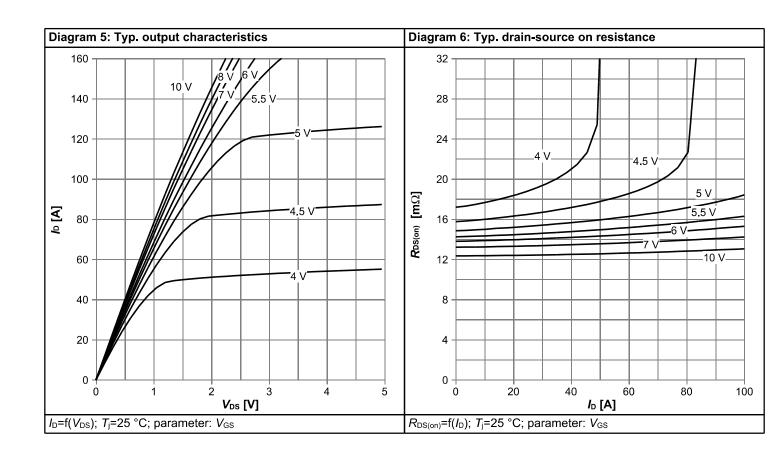


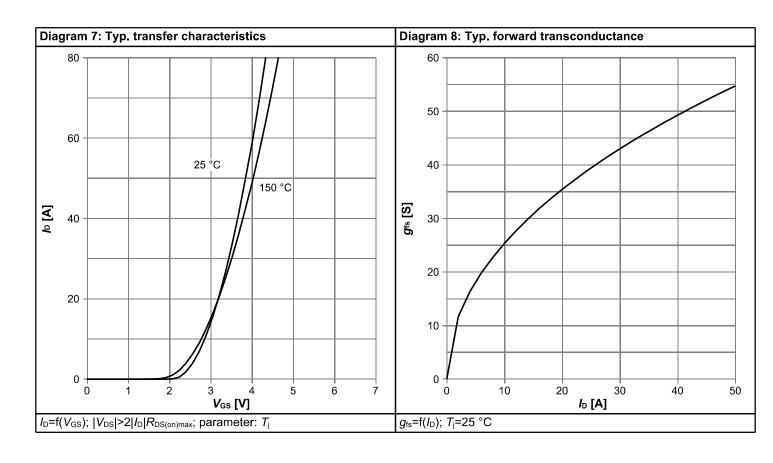
4 Electrical characteristics diagrams



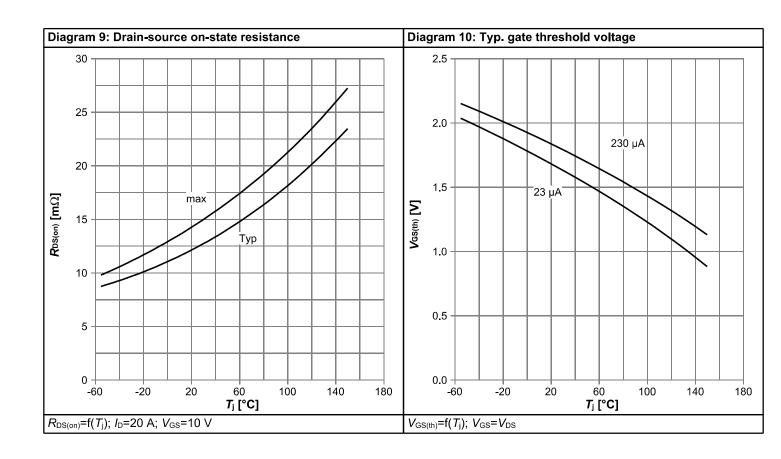


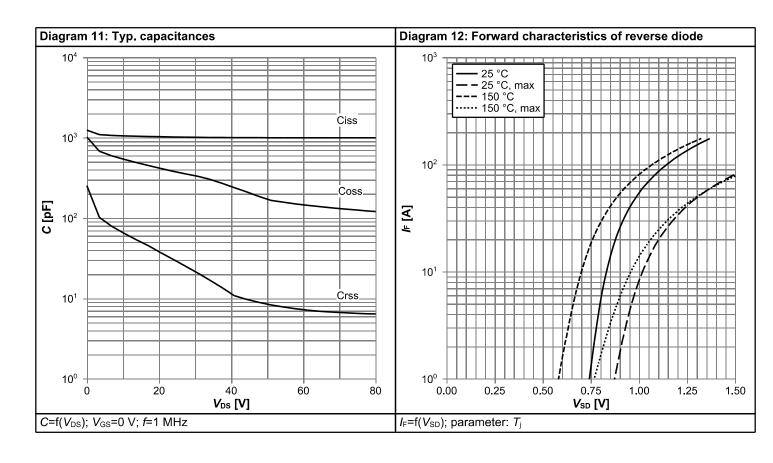




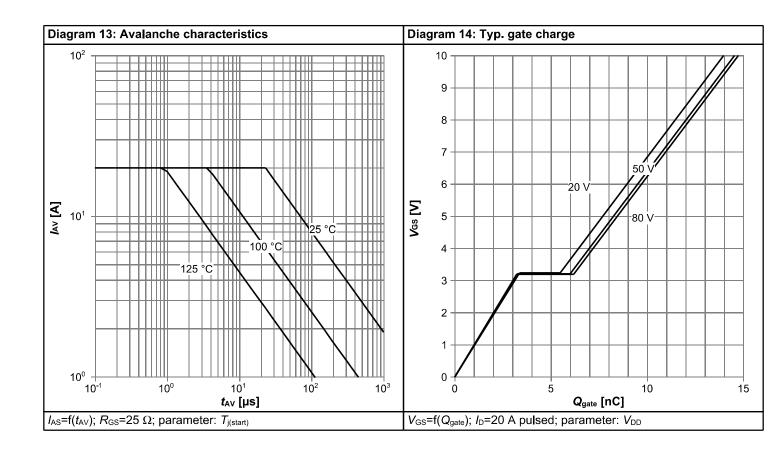


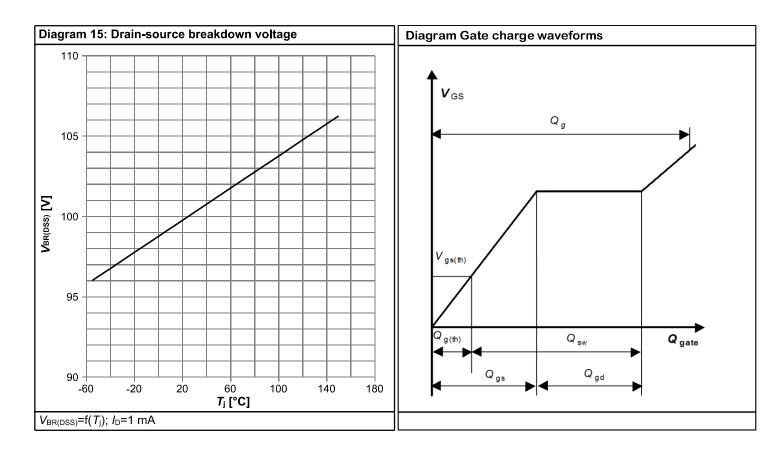






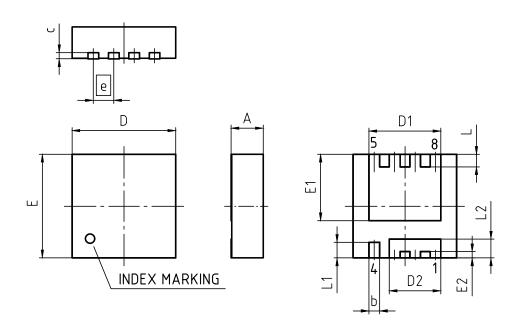








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	ON-8-U03		
REVISION: 03	DATE:	20.10.2020		
DIMENSIONS	MILLIM	ETERS		
DIMENSIONS	MIN.	MAX.		
Α	0.90	1.10		
b	0.24	0.44		
С	(0.	20)		
D	3.20	3.40		
D1	2.19	2.39		
D2	1.54	1.74		
E	3.20	3.40		
E1	2.01	2.21		
E2	0.10	0.30		
е	0.65			
L	0.30	0.50		
L1	0.40	0.60		
L2	0.50	0.70		
aaa	0.0)6		

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



Revision History

BSZ146N10LS5

Revision: 2021-03-17, Rev. 2.3

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2016-03-23	Release of final version
2.1	2016-04-21	Update Gate threshold voltage (VGSth)
2.2	2016-08-10	Update in Qrr and trr
2.3	2021-03-17	Update current rating and POD

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